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Orderable: N/A		Designed for: Public Release		Mod. Date: 7/12/2017	
TID #:		Project Title: 400W Phase Shifted Full Bridge for 48V Automotive			
Number: TIDA-01407		Rev: B		Sheet Title: Gate Driver Primary and Secondary	
SVN Rev: Version control disabled		Assembly Variant: 001		Sheet: 2 of 2	
Drawn By:		File: Gate Drivers High Side and Low Side.SchDoc		Size: B	
Engineer: R Manack		Contact: http://www.ti.com/support			

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